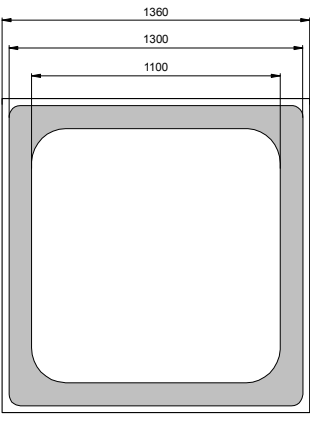


Wavelength range	Type	Technology	Electrodes
UV-blue-green	Schottky Contact	GaP	P (anode) up

	typ. dimensions (µm)	
	typ. thickness 300 µm  anode gold alloy, 1.5 µm  cathode gold alloy, 0.5 µm	<b>Description</b> High spectral sensitivity in the blue and ultraviolet range, low dark currents, low cost chip with high degradation stability  <b>Applications</b> special light barriers, sensors for flame control and automation

## Miscellaneous Parameters

$T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test conditions	Symbol	Value	Unit
Active area		A	1.2	mm <sup>2</sup>
Temperature coefficient of $I_D$		$T_C(I_D)$	7.0	%/K
Operating temperature range		$T_{amb}$	-40 to +125	°C
Storage temperature range		$T_{stg}$	-40 to +125	°C

## Optical and Electrical Characteristics

$T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified

Parameter	Test conditions	Symbol	Min	Typ	Max	Unit
Dark current	$V_R = 5\text{ V}$	$I_D$		10	30	pA
Peak sensitivity wavelength	$V_R = 0\text{ V}$	$\lambda_p$		440		nm
Responsivity at $\lambda_p^*$	$V_R = 0\text{ V}$	$S_\lambda$		0.17		A/W
Sensitivity range at 1%	$V_R = 0\text{ V}$	$\lambda_{min}, \lambda_{max}$	<110		570	nm
Spectral bandwidth at 50%	$V_R = 0\text{ V}$	$\Delta\lambda_{0.5}$		180		nm
Shunt resistance	$V_R = 10\text{ mV}$	$R_D$	150	200		GΩ
Noise equivalent power	$\lambda = 440\text{ nm}$	NEP		$1.1 \times 10^{-14}$		W/ $\sqrt{\text{Hz}}$
Junction capacitance	$V_R = 0\text{ V}$	$C_J$		300		pF
Switching time ( $R_L = 50\ \Omega$ )	$V_R = 5\text{ V}$	$t_r, t_f$		1/20		ns

\*Measured on bare chip on TO-18 header with *EPIGAP* equipment

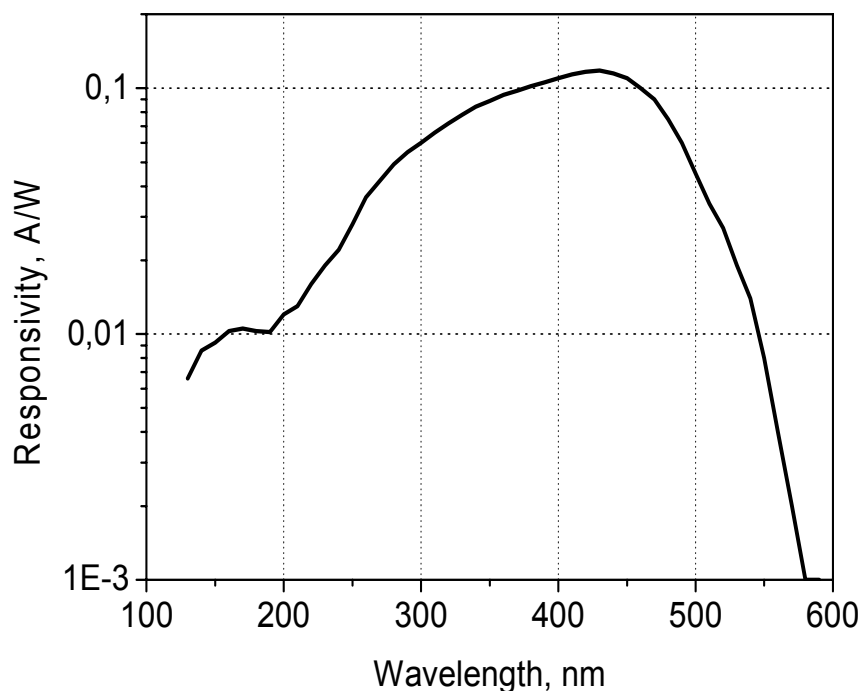
## Labeling

Type	Typ. $I_D$ [pA]	Typ. $S_\lambda$ [A/W]	Lot N°	Quantity
EPC-440-1.4				

**Packing:** Chips on adhesive film with wire-bond side on top

We reserve the right to make changes to improve technical design and may do so without further notice.  
 Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer.

Typical responsivity spectrum



### Handling instructions of UV-photodiode dies on blue tape (Nitto's SWT 20)

EPIGAP's UV-photodiode dies are delivered on adhesive blue tape rings. For mounting these dies have to be removed from the tape. They are sensitive to surface touching so they should only be handled from the side. To minimize mechanical stress or chipping use only plastic tweezers or die collets for picking. Because larger dies are stronger stuck to the tape use one round point needle of about 1mm diameter or several pin point needles from the rear side to loosen the dies before picking.